

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (L²-π-MOS V)

2SK2266

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

INDUSTRIAL APPLICATIONS

Unit in mm

- 4V Gate Drive
- Low Drain-Source ON Resistance : $R_{DS(ON)} = 22m\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 27S$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100\mu A$ (Max.) ($V_{DS} = 60V$)
- Enhancement-Mode : $V_{th} = 0.8 \sim 2.0V$ ($V_{DS} = 10V, I_D = 1mA$)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Drain-Gate Voltage ($R_{GS} = 20k\Omega$)		V_{DGR}	60	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	DC	I_D	45	A
	Pulse	I_{DP}	180	
Drain Power Dissipation ($T_c = 25^\circ C$)		P_D	65	W
Single Pulse Avalanche Energy**		E_{AS}	246	mJ
Avalanche Current		I_{AR}	45	A
Repetitive Avalanche Energy*		E_{AR}	6.5	mJ
Channel Temperature		T_{ch}	150	°C
Storage Temperature Range		T_{stg}	-55~150	°C

THERMAL CHARACTERISTICS

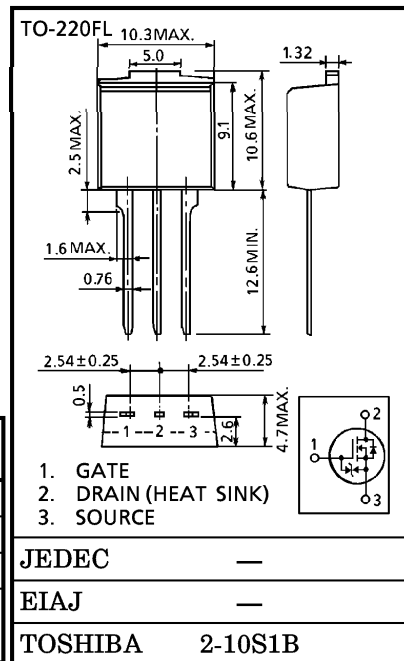
CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	1.92	°C/W
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	83.3	°C/W

Note ;

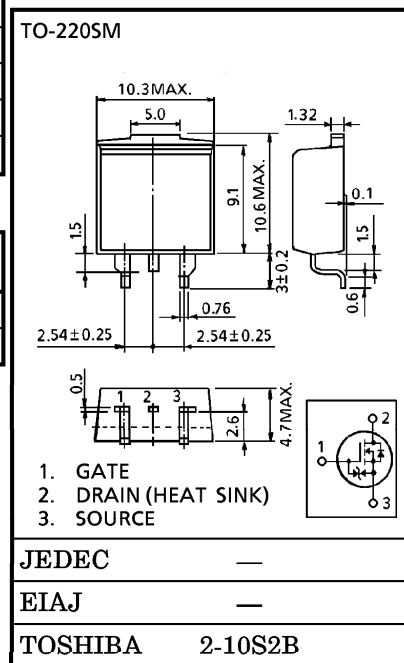
* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

** $V_{DD} = 90V$, Starting $T_{ch} = 25^\circ C$, $L = 165\mu H$, $R_G = 25\Omega$, $I_{AR} = 45A$

This transistor is an electrostatic sensitive device. Please handle with caution.



Weight : 1.5g (Typ.)



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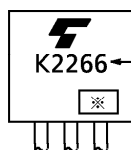
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Gate Leakage Current	I _{GSS}	V _{GS} = ±16V, V _{DS} = 0V	—	—	±10	μA	
Drain Cut-off Current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V	—	—	100	μA	
Drain-Source Breakdown Voltage	V (BR) DSS	I _D = 10mA, V _{GS} = 0V	60	—	—	V	
Gate Threshold Voltage	V _{th}	V _{DS} = 10V, I _D = 1mA	0.8	—	2.0	V	
Drain-Source ON Resistance	R _{D(S) ON}	V _{GS} = 4V, I _D = 15A	—	40	55	mΩ	
		V _{GS} = 10V, I _D = 25A	—	22	30		
Forward Transfer Admittance	Y _{fs}	V _{DS} = 10V, I _D = 25A	15	27	—	S	
Input Capacitance	C _{iss}	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz	—	1800	—	pF	
Reverse Transfer Capacitance	C _{rss}		—	350	—		
Output Capacitance	C _{oss}		—	900	—		
Switching Time	Rise Time	t _r		—	20	—	ns
	Turn-on Time	t _{on}		—	30	—	
	Fall Time	t _f		—	40	—	
	Turn-off Time	t _{off}		V _{IN} : t _r , t _f < 5ns Duty ≤ 1%, t _w = 10μs	—	130	
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q _g	V _{DD} ≈ 48V, V _{GS} = 10V	—	60	—	nC	
Gate-Source Charge	Q _{gs}	I _D = 45A	—	40	—		
Gate-Drain ("Miller") Charge	Q _{gd}		—	20	—		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I _{DR}	—	—	—	45	A
Pulse Drain Reverse Current	I _{DRP}	—	—	—	180	A
Diode Forward Voltage	V _{DSF}	I _{DR} = 45A, V _{GS} = 0V	—	—	-1.8	V
Reverse Recovery Time	t _{rr}	I _{DR} = 45A, V _{GS} = 0V	—	90	—	ns
Reverse Recovery Charge	Q _{rr}	dI _{DR} / dt = 50A / μs	—	0.1	—	μC

MARKING

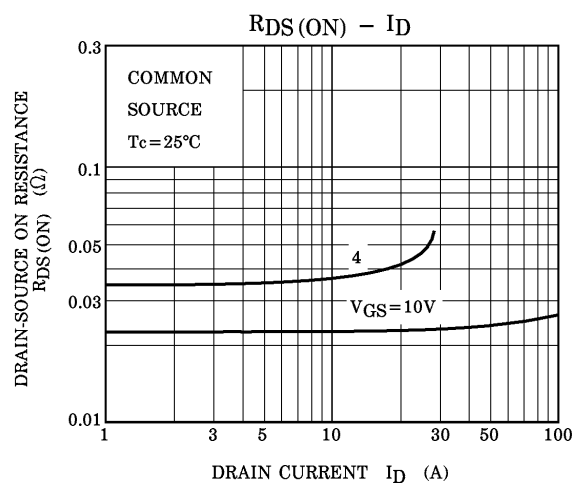
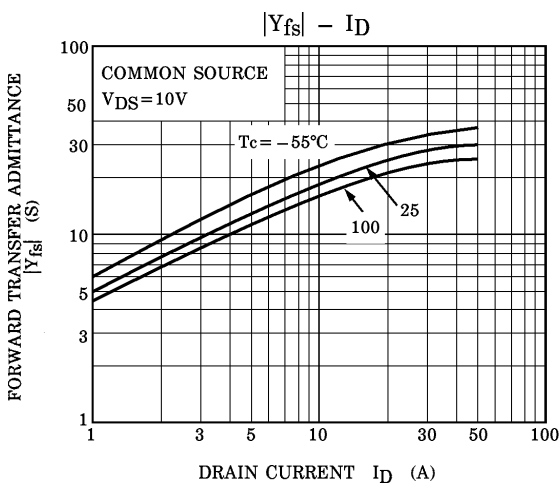
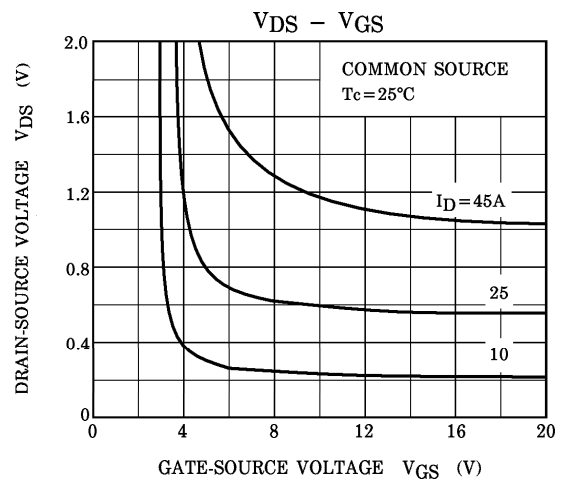
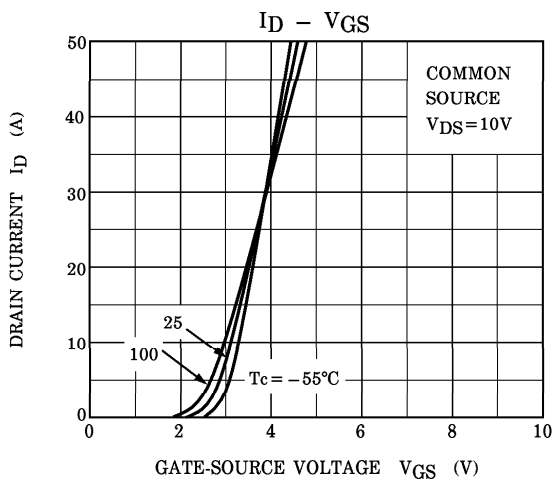
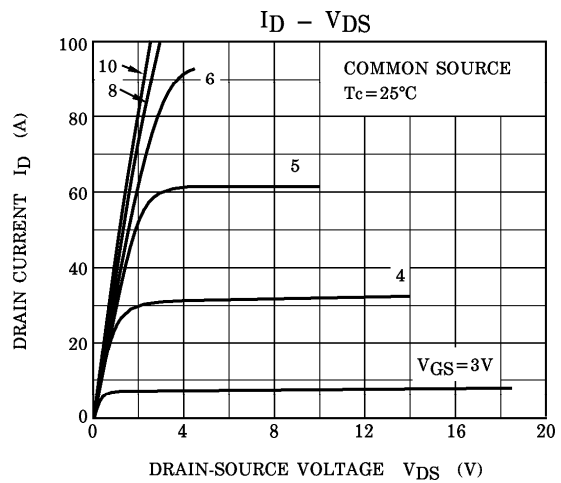
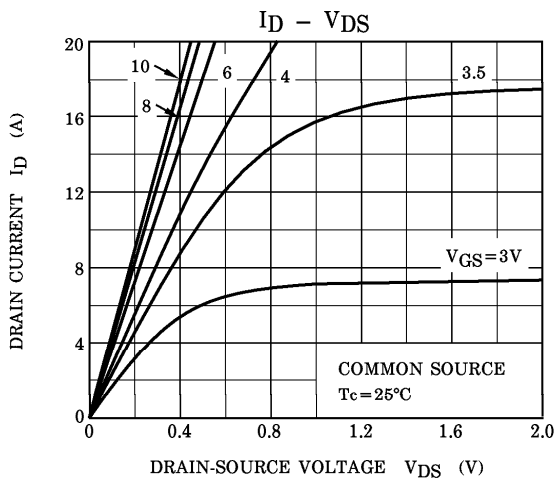


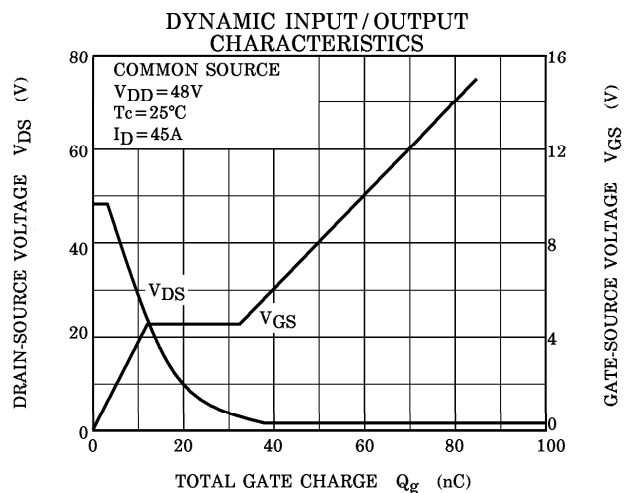
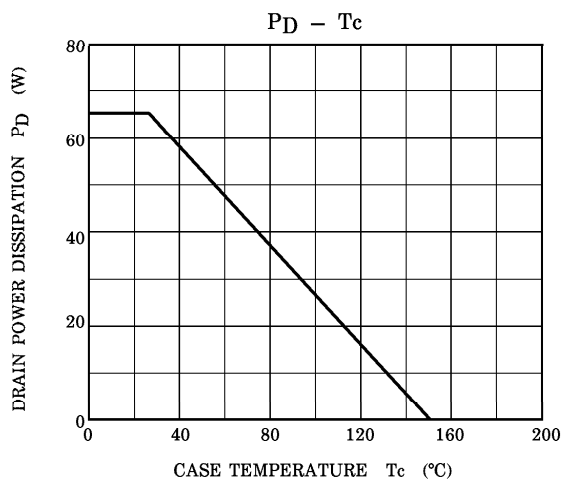
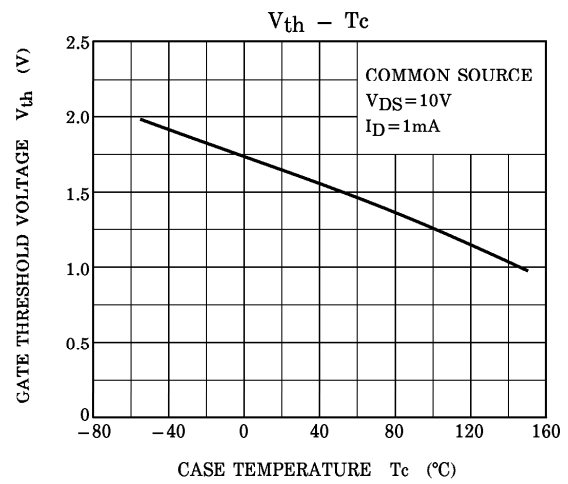
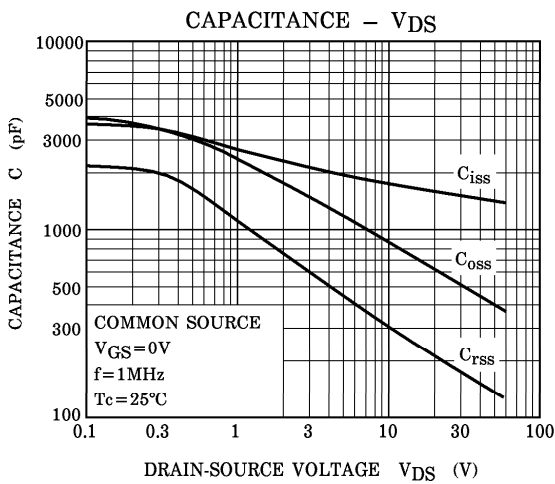
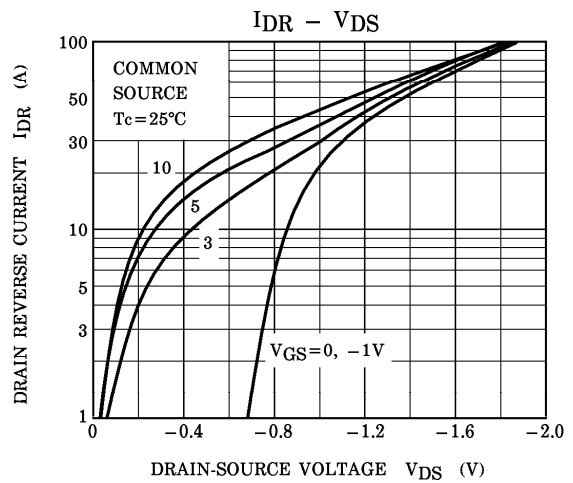
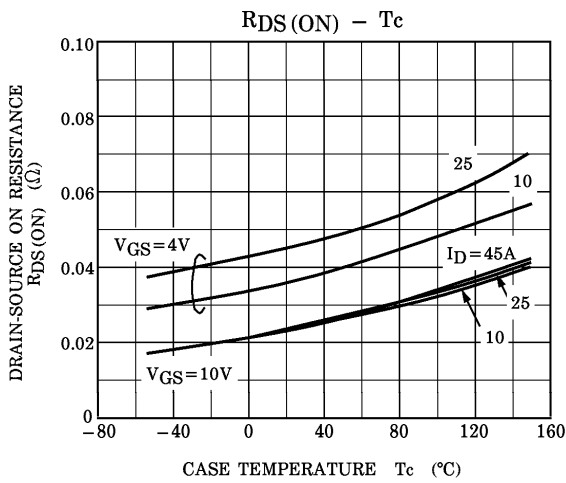
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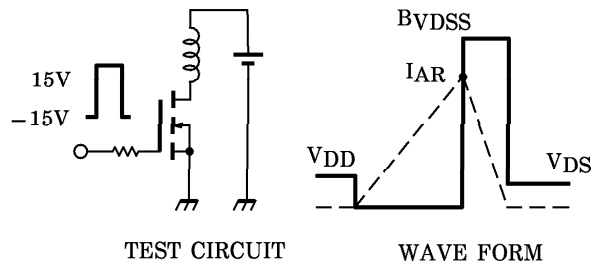
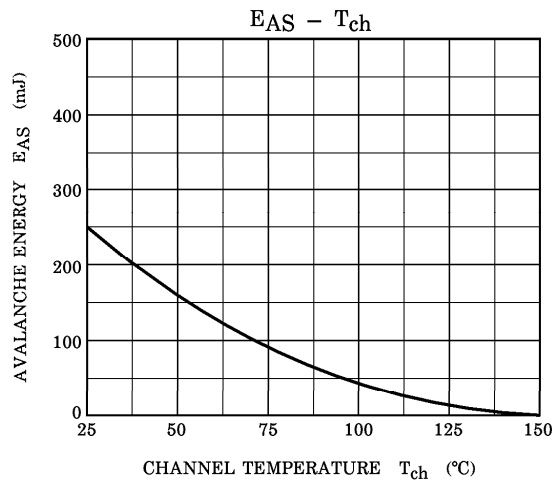
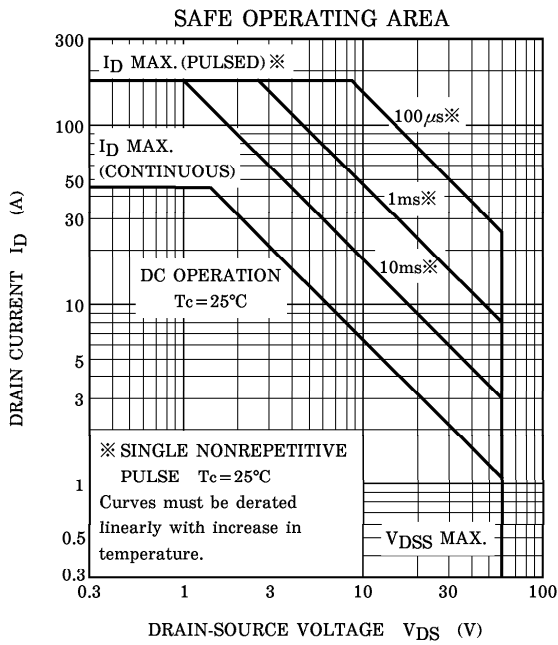
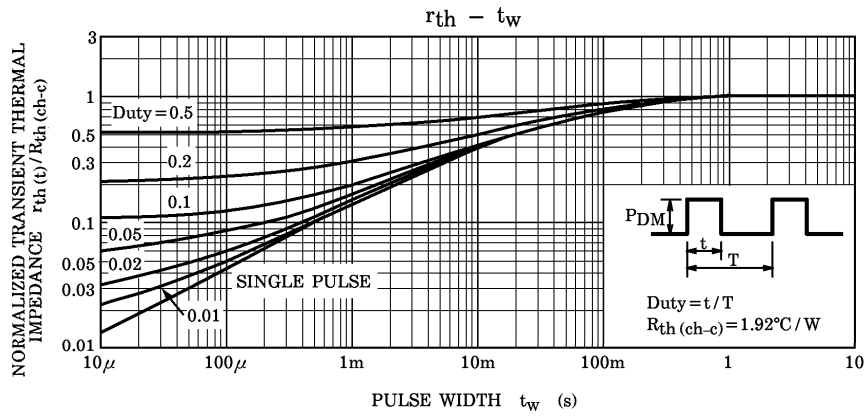
※ Lot Number

□ □ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)







Peak $I_{AR} = 45A$, $R_G = 25\Omega$
 $V_{DD} = 25V$, $L = 165\mu H$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - V_{DD}} \right)$$